

EL TOP VIEW LED 67-21R-SR0201H-AM



Features

- Package : PLCC 2 package
- Color : Super Red
- Typ. Luminance Intensity : 800 mcd @ 20mA
- Viewing angle : 120°
- ESD : 2KV
- MSL : 2
- Qualified AEC-Q102
- Sulfur robustness : Class A1
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Applications

- Automotive interior lighting
- Automotive exterior lighting

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1. Characteristics

Parameter		Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Current		I_F	5	20	50	mA	---
Luminous Intensity		I_V	560	800	1400	mcd	$I_F=20\text{mA}$
Forward Voltage		V_F	1.75	2.00	2.75	V	$I_F=20\text{mA}$
Viewing Angle		φ	---	120	---	deg	$I_F=20\text{mA}$
Dominant Wavelength		λ_d	627	---	639	nm	$I_F=20\text{mA}$
Thermal Resistance (Junction to Solder)	Real	$R_{th\ JS\ real}$	---	120	160	K/W	$I_F=20\text{mA}$
	Electrical	$R_{th\ JS\ el}$	---	100	120		

Notes:

1. Luminous Flux measurement tolerance: $\pm 8\%$.
2. The data of Luminous Flux measured at thermal pad= 25°C
3. Forward voltage measurement tolerance: $\pm 0.05\text{V}$
4. The V_F range shown in the table above indicates 99% output.
5. Tolerance of Dominant Wavelength : $\pm 1\text{nm}$.

2. Absolute Maximum Ratings

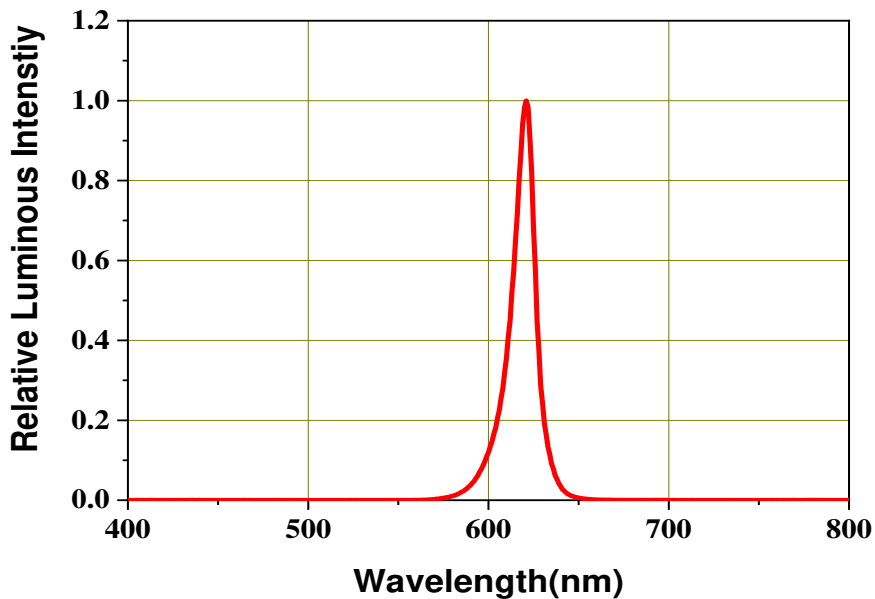
Parameter	Symbol	Ratings	Unit
Power Dissipation	P_d	137	mW
Forward Current	I_F	50	mA
Surge Current ($t \leq 10 \mu\text{s}$; $D=0.005$; $T_s=25 \text{ }^\circ\text{C}$)	I_{FM}	100	mA
Reverse Voltage	V_R	Not designed for reverse operation	V
Junction Temperature	T_J	125	$^\circ\text{C}$
Operating Temperature	T_{opr}	-40 ~ +110	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 ~ +110	$^\circ\text{C}$
ESD Sensitivity ($R=1.5\text{k}\Omega$, $C=100\text{pF}$)	ESD_{HBM}	2	kV
Soldering Temperature	Reflow	260 $^\circ\text{C}$ for 30sec	$^\circ\text{C}$

3. Characteristics Graph

Wavelength Characteristics Relative Spectral Distribution

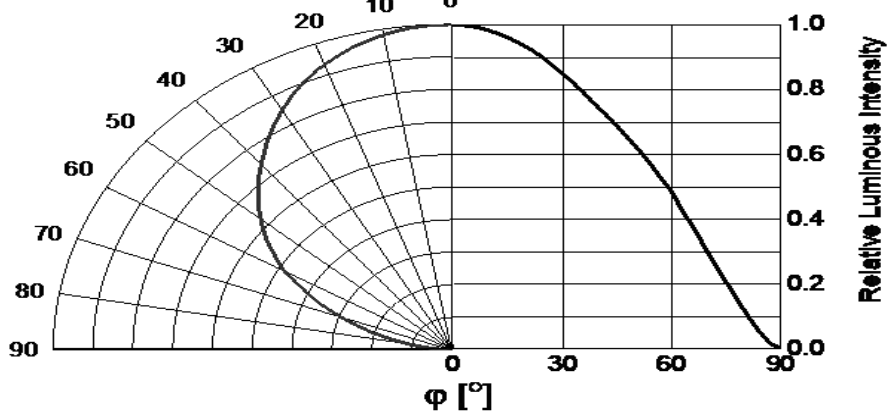
@ Ts = 25°C, If=20mA

$$\Phi_V / \Phi_V (Max.) = f(\lambda)$$



Typical Diagram Characteristics of Radiation

$$\Phi_V / \Phi_V (0^\circ) = f(\varphi)$$



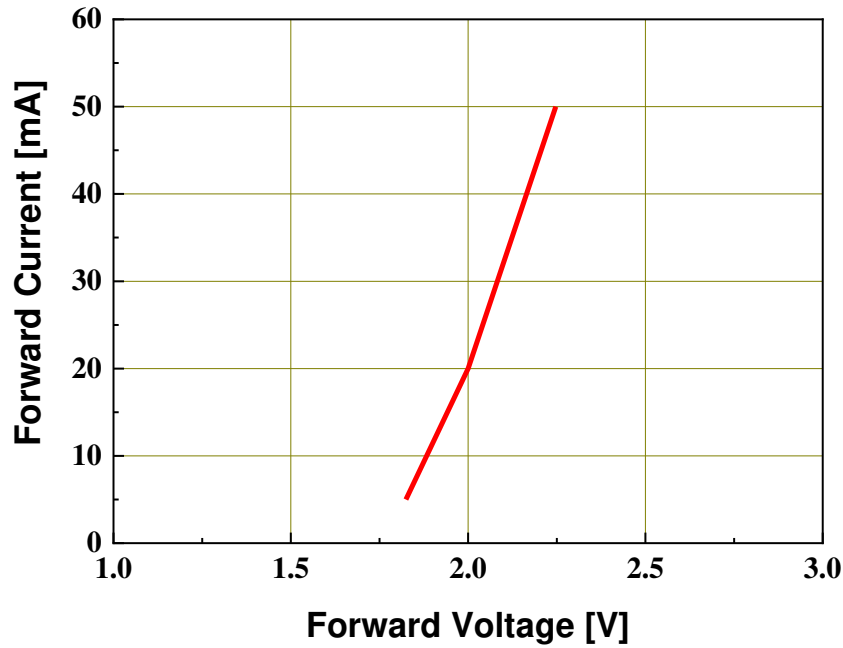
Notes:

1. φ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
2. View angle tolerance is $\pm 5^\circ$.

Forward Current vs. Forward Voltage

@ Ts = 25°C

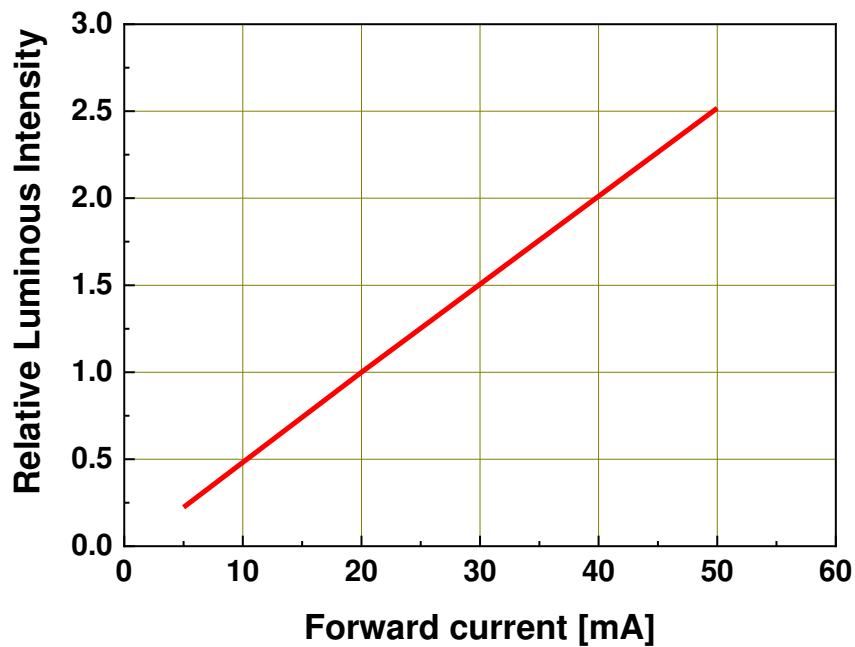
$$I_F = f(V_F)$$



Relative Luminous Intensity vs. Forward Current

@ Ts = 25°C

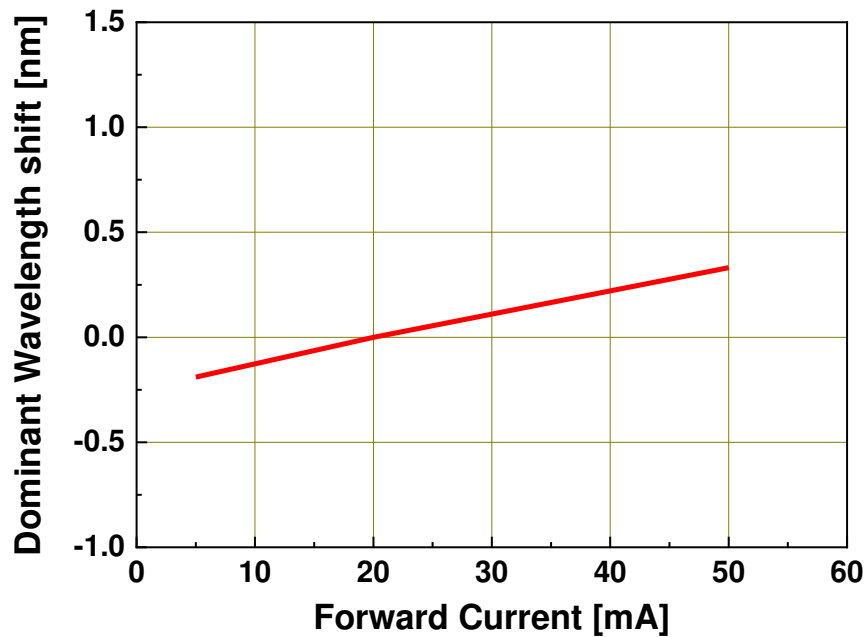
$$\Phi_V / \Phi_V(20mA) = f(I_F)$$



Dominant Wavelength shift vs. Forward Current

@ $T_s = 25^\circ\text{C}$

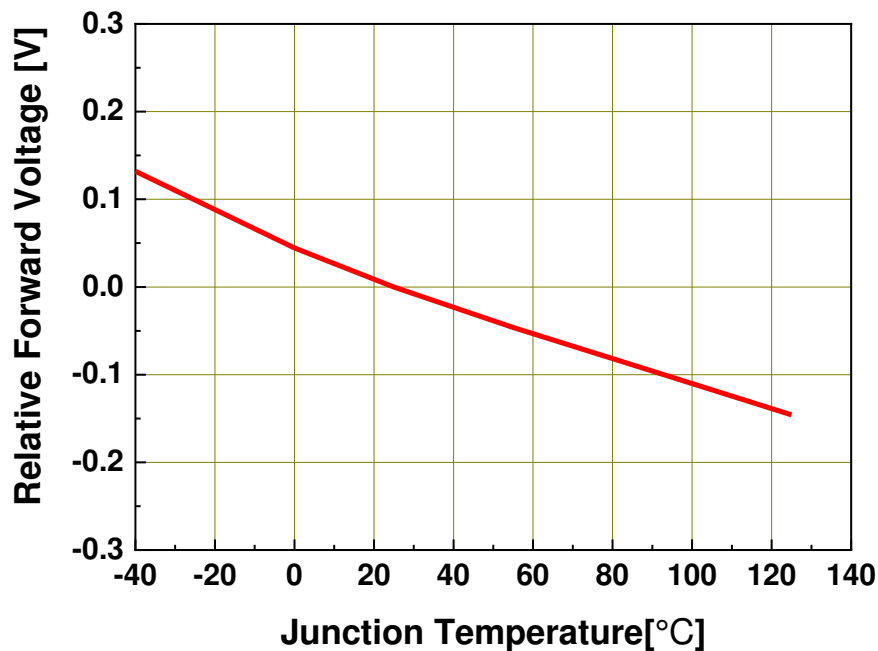
$$\Delta\lambda_d = \lambda_d - \lambda_d(20\text{mA}) = f(I_F)$$



Relative Forward Voltage vs. Junction Temperature

@ $I_F = 20\text{mA}$

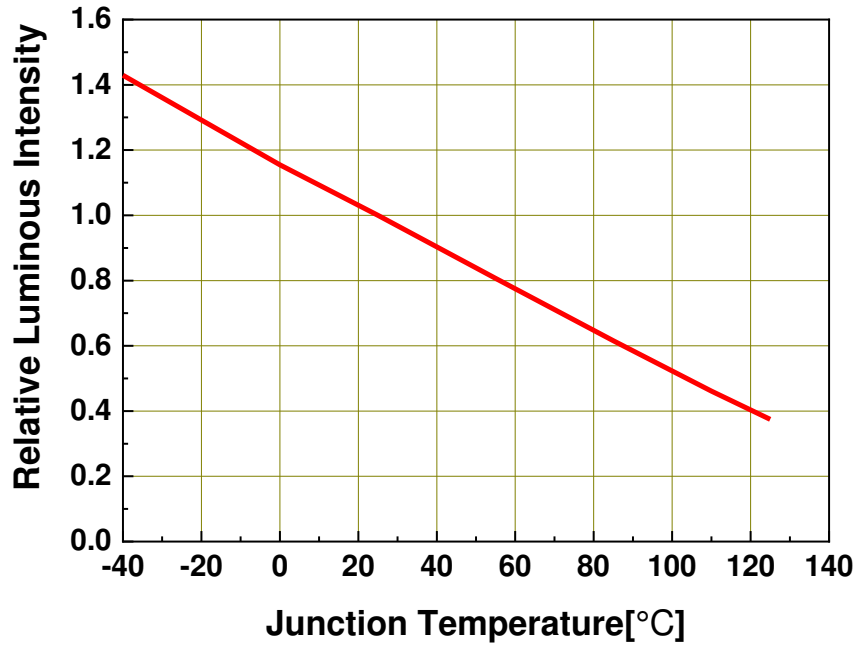
$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j)$$



Relative Luminous Intensity vs. Junction Temperature

@ $I_F=20\text{mA}$

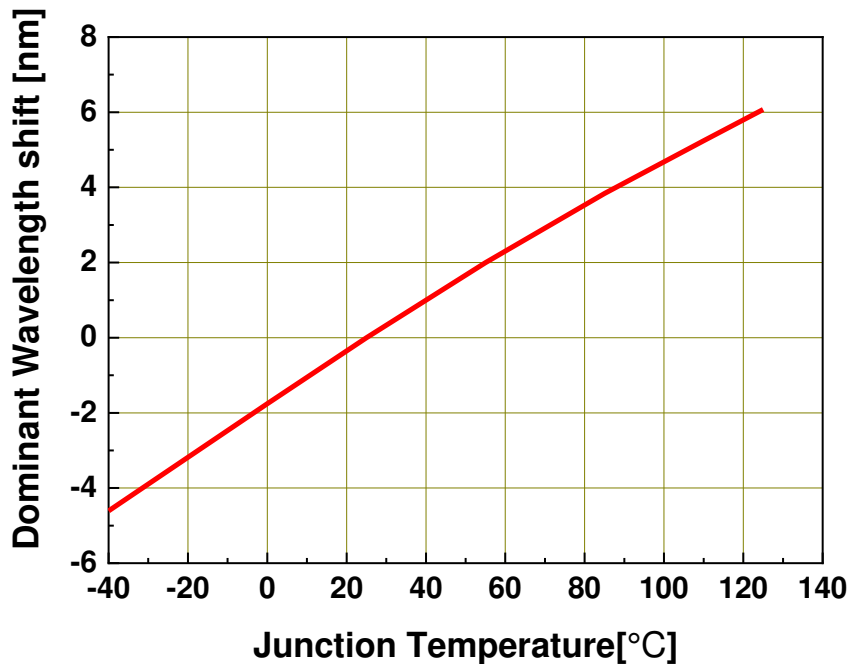
$$\Phi_v / \Phi_v(25^\circ\text{C}) = f(T_j)$$



Dominant Wavelength Shift vs. Junction Temperature

@ $I_F=20\text{mA}$

$$\Delta\lambda_d = \lambda_d - \lambda_d(25^\circ\text{C}) = f(T_j)$$



4. Binning Information

Luminous Intensity Bins

Group Bin	Luminous Intensity (mcd)		Luminous flux (lm)(for reference)		
	Min.	Max.	Min.	Max.	
U2	560	710	1.76	2.23	
V1	V11	710	800	2.23	2.35
	V12	800	900	2.35	2.83
V2	900	1120	2.83	3.52	
AA	1120	1400	3.52	4.40	

Notes:

1. Luminous flux measurement tolerance: $\pm 8\%$.
2. Test current: Typical forward current
3. Current pulse time: 25ms

Dominant Wavelength Bins

Group Bin	Minimum Dominant Wavelength [nm]	Maximum Dominant Wavelength [nm]
2730	627	630
3033	630	633
3336	633	636
3639	636	639

Notes:

1. Dominant wavelength measurement tolerance: $\pm 1\text{nm}$
2. Test current: Typical forward current
3. Current pulse time: 25ms

Forward Voltage Bins

Bin code	Min Forward Voltage [V]	Max Forward Voltage [V]
1720	1.75	2.00
2022	2.00	2.25
2225	2.25	2.50
2527	2.50	2.75

Notes:

1. Forward voltage measurement tolerance: $\pm 0.05\text{V}$
2. Test current: Typical forward current
3. Current pulse time: 25ms

5. Part Number

67-21R-SR0201H-AM

Part number is designated with below details.

67-21 = Product family name.

R = Reverse polarity

SR = Color ^[1]

020 = Test current [mA]

1 = Lead Frame Type

H = Brightness Level (H=High ; M=Medium ; L=Low)

AM = Automotive application

Note

[1] Color :

Symbol	Description
C	Cool White
N	Neutral White
W	Warm White
PA	Phosphor Converted Amber
PR	Phosphor Converted Red
UB	Blue
IB	Ice Blue
SB	Sky Blue
UP	Purple
UG	Green
UY	Yellow
UYG	Brilliant Yellow Green
UPG	Pale Green
UA	Amber
UR	Red
SR	Super Red
RGB	RGB-Color
PYG	Phosphor Converted Yellow Green

6. Ordering Information

67-21R-SR0201H-ABCDEFGHJKLM-NO-AM

Part Number of the 67-21	Order Code
67-21R-SR0201H-AM	67-21R-SR0201H-ABCDEFGHJKLM-NO-AM

Order code contains information with below details :

ABCD = min/max wavelength or CCT

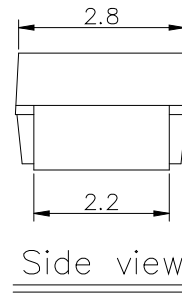
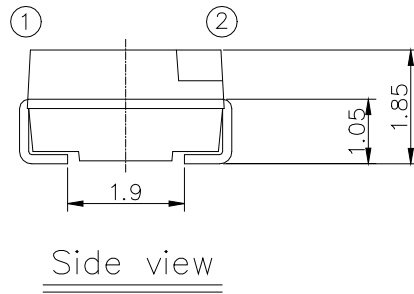
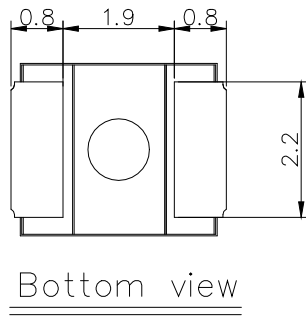
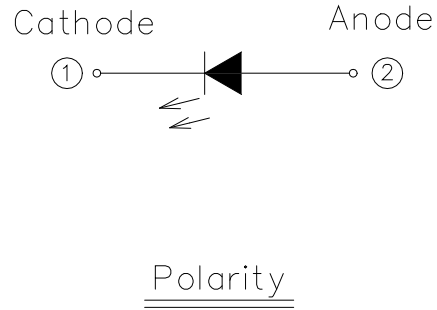
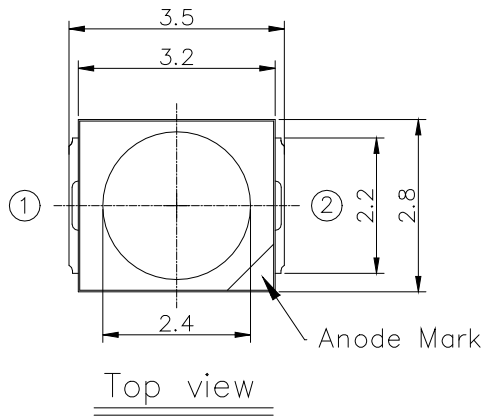
EFGH = min./max. luminous flux in [lm] or luminous intensity in [mcd]

JKLM = min./max. forward voltage

NO = internal code

AM = Automotive Application

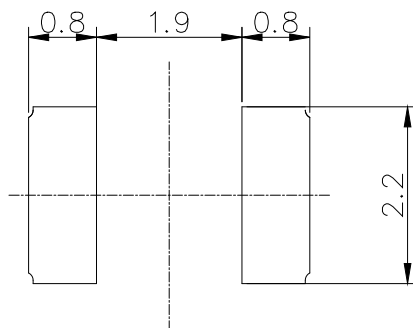
7. Mechanical Dimension



Notes:

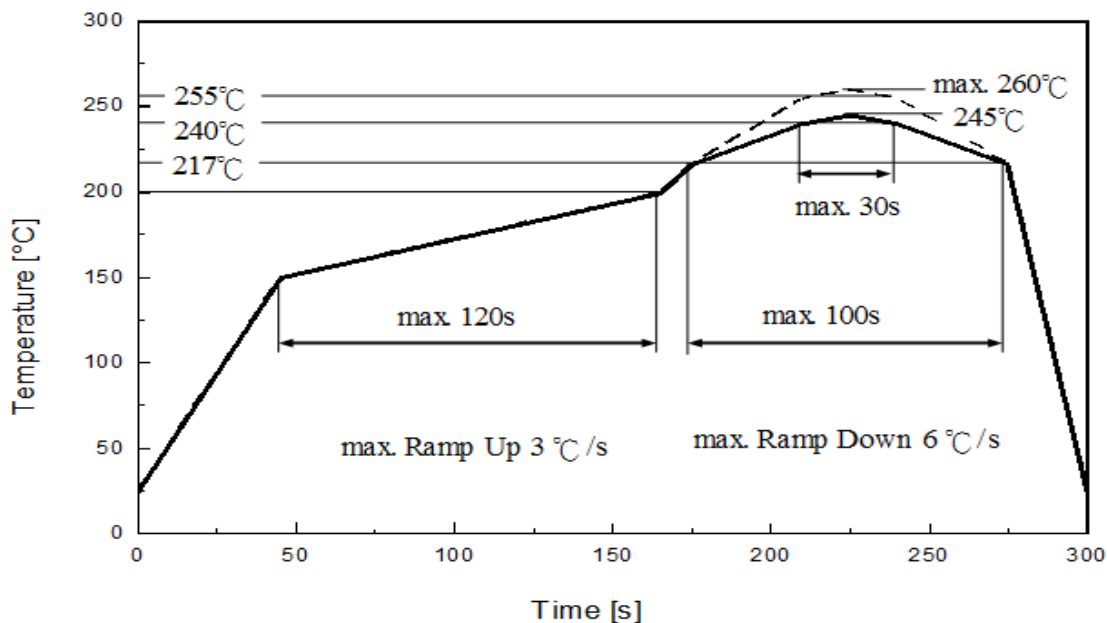
- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are $\pm 0.1\text{mm}$.

8. Recommended Soldering Pad



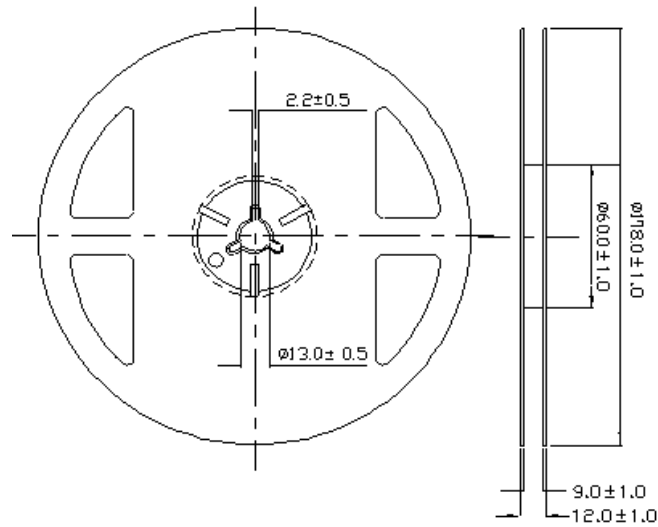
9. Reflow Soldering Profile

Soldering Condition (Reference: IPC/JEDEC J-STD-020D)



Profile Feature	Pb-Free Assembly	Unit
	Recommendation	
Ramp-up rate to preheat 25 °C to 150 °C	3	°C /sec
Time of soaking zone 150 °C to 200 °C	120	sec
Ramp-up rate to peak	3	°C /sec
Liquidus temperature	217	°C
Time above liquidus temperature	100	sec
Peak temperature (max.)	260	°C
Time within 5°C of the specified peak temperature	30	sec
Ramp-down Rate (max.)	6	°C /sec

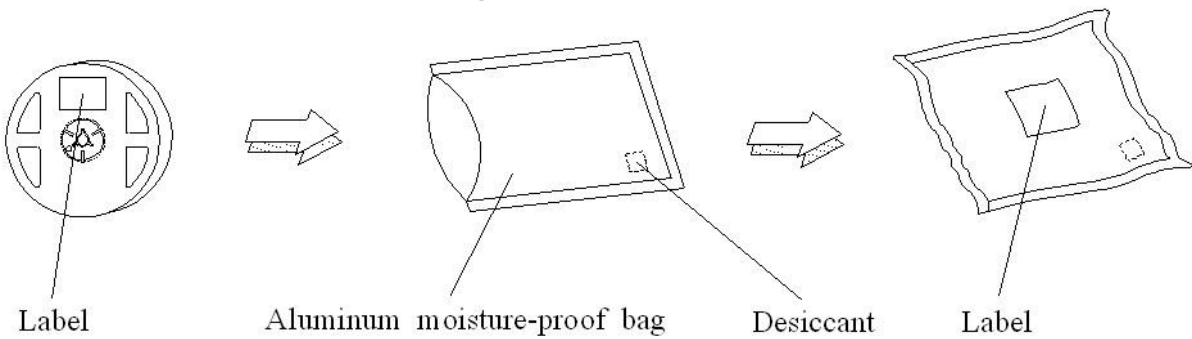
● Reel Dimensions



Notes:

1. Dimensions are in millimeters.
2. Tolerances for fixed dimensions are ± 0.2 mm.

● Moisture Resistant Packing Process



Notes:

1. Dimensions are in millimeters.
2. Tolerances unless mentioned are ± 0.2 mm.

11. Precaution for Use

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (burn out will happen).

2. Assemblies

Do not stack assemblies containing LEDs to prevent damage to the optical surface of LEDs. Forces applied to the optical surface may result in the surface being damaged.

3. Soldering Condition

3.1 When soldering, do not put stress on the LEDs during heating.

3.2 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

12. Sulfur Test Criteria

Products	Failure Criteria
Exterior Lighting products	Luminous Flux +/-20%, forward voltage +/-10%, color coordinates x,y +/-0.01, color wavelength +/- 2 nm Visual defect issue following Everlight's inspection criteria
Interior lighting products	Luminous Flux +/-30% or +/-50% for some application, forward voltage +/-10%, color coordinates x,y +/-0.02, color wavelength +/- 2 nm Visual defect issue following Everlight's inspection criteria
Grade of H2S and FMG test	Please refer to the table as below. As for discolor, please refer to the Frame blackening after Grade of H2S and FMG test defect under Everlight's inspection criteria

	Grade A0	Grade A1	Grade B0	Grade B1
C12 H2S Class A C13 FMG	No corrosion	Corrosion without the impact on reliability and life time, following AEC-Q102 rev. A		
C12 H2S Class B C13 FMG			No corrosion	Corrosion without the impact on reliability and life time, following AEC-Q102 rev. A

Class for H2S Test & FMG	Description	
	H2S	FMG
Class A	15 ppm with duration 336 h at 40 °C and 90% RH.	Duration 500 h at 25 °C and 75% RH. H2S concentration: 10ppb SO2 concentration: 200ppb NO2 concentration: 200ppb Cl2 concentration: 10ppb
Class B	10 ppm with duration 500 h at 25 °C and 75% RH.	

Class for H2S Test & FMG	Description
0	No corrosion found
1	Corrosion without the impact on reliability and life time, following AEC-Q102 rev. A

Revision History

Current version: 17.Jul.2025

Issue No: DSE-0024505

Version: 1

Created by: Howard Deng

Rev.	Subjects (major change in previous version)	Modified date
1	Standard datasheet	2025.07.17